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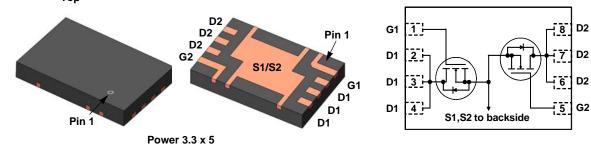
# **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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100 V, 21 A, 20 mΩ					
Features	General Description				
• Max $r_{DS(on)}$ = 20 m $\Omega$ at V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A	This package integrates two N-Channel devices connected				
Max $r_{DS(on)}$ = 32 m $\Omega$ at V <sub>GS</sub> = 6 V, I <sub>D</sub> = 5.5 A	internally in common-source configuration. This enables very low package parasitics and optimized thermal path to the common source pad on the bottom. Provides a very small footprint (3.3 x 5 mm) for higher power density.				
Ideal for flexible layout in secondary side synchronous rectification					
Termination is Lead-free and RoHS Compliant	Applications				
■ 100% UIL tested	Isolated DC-DC Synchronous Rectifiers				
No. of the second se	Common Ground Load Switches				
Top Bottom					
	Pin 1 G1 $1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$ $1$				



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		21		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	7	A	
	-Pulsed		(Note 4)	80		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
D	Power Dissipation	T <sub>C</sub> = 25 °C		23	14/	
P <sub>D</sub> Power Dissipation	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.1	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	5.3	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	60	C/vv

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
84100	FDMD84100	Power 3.3 x 5	13 "	12 mm	3000 units

June 2016

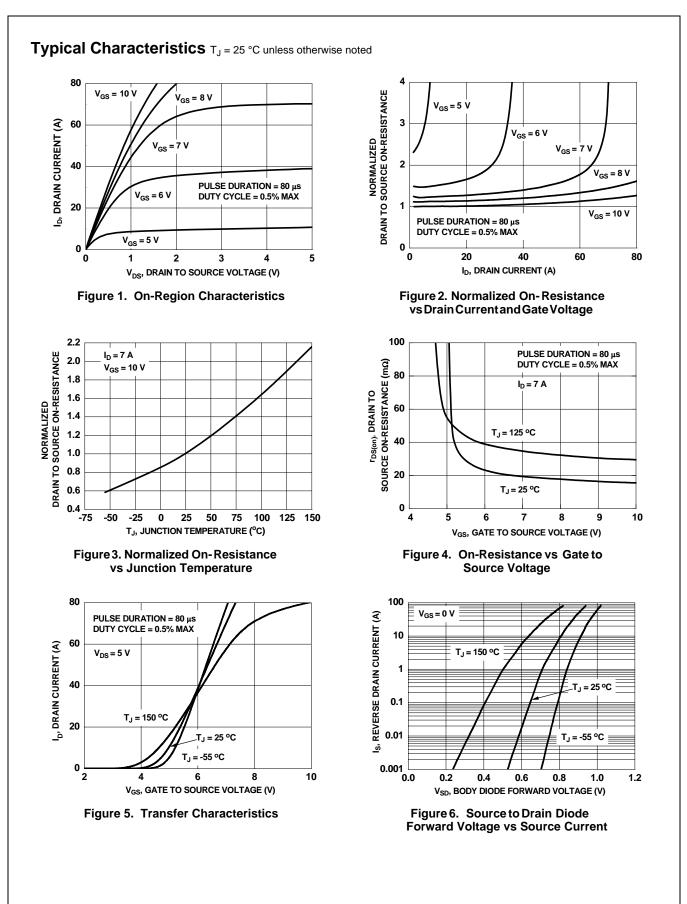


## FDMD84100 Dual N-Channel PowerTrench<sup>®</sup> MOSFET 1

### F

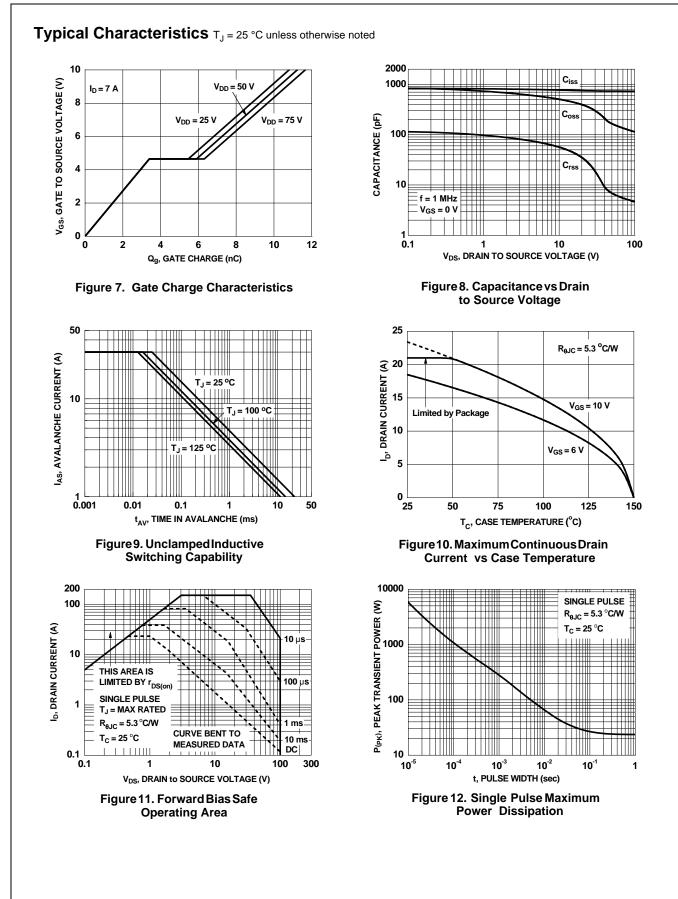
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istics in to Source Breakdown Voltage akdown Voltage Temperature officient o Gate Voltage Drain Current e to Source Leakage Current istics	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 250 \ \mu A, \ referenced to 25 \ ^C$ $V_{DS} = 80 \ V, \ V_{GS} = 0 \ V$	100			
in to Source Breakdown Voltage akdown Voltage Temperature efficient o Gate Voltage Drain Current e to Source Leakage Current	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C	100			
akdown Voltage Temperature officient o Gate Voltage Drain Current e to Source Leakage Current	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C	100			V
o Gate Voltage Drain Current e to Source Leakage Current	$V_{PQ} = 80 V V_{QQ} = 0 V$		74		mV/°(
e to Source Leakage Current				1	μA
	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
istics				2.00	
			0.4		
e to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	3.1	4	V
e to Source Threshold Voltage	$I_D$ = 250 µA, referenced to 25 °C		-9		mV/°
	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		16	20	
Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 5.5 A		24	32	mΩ
	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		30	38	
ward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 7 A		17		S
ractoristics			ł		4
			734	980	pF
	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V				pF
	f = 1 MHz			-	pF
		0.1			Ω
		0		0	
					-
					ns
					ns
•	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$				ns
					ns
	$V_{GS} = 0 V \text{ to } 10 V$		11		nC
	$V_{GS} = 0 V \text{ to } 6 V V_{DD} = 50 V$			11	nC
-	I <sub>D</sub> = 7 A				nC
e to Drain "Miller" Charge			2.5		nC
Diode Characteristics					
rce to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7 A$ (Note 2)		0.8	1.2	V
verse Recovery Time	$I = 7 \wedge di/dt = 100 \wedge lus$		43	70	ns
verse Recovery Charge	$I_{\rm F} = 7$ A, di/dl = 100 A/µs		44	71	nC
	ic Drain to Source On Resistance ward Transconductance racteristics ut Capacitance put Capacitance rerse Transfer Capacitance e Resistance aracteristics n-On Delay Time a Time a Gate Charge e to Source Charge e to Drain "Miller" Charge Diode Characteristics rce to Drain Diode Forward Voltage rerse Recovery Time	Inperature CoefficientID $250 \ \mu$ A, referenced to $25 \ ^{\circ}$ Cic Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 7 \ A$ ward Transconductance $V_{GS} = 6 \ V, \ I_D = 7 \ A, \ T_J = 125 \ ^{\circ}$ Cward Transconductance $V_{DD} = 5 \ V, \ I_D = 7 \ A$ racteristics $V_{DD} = 5 \ V, \ I_D = 7 \ A$ racteristics $V_{DD} = 50 \ V, \ V_{GS} = 0 \ V$ racteristics $V_{DD} = 50 \ V, \ V_{GS} = 0 \ V$ rese Transfer Capacitance $V_{DD} = 50 \ V, \ I_D = 7 \ A$ e Resistance $V_{DD} = 50 \ V, \ I_D = 7 \ A$ n-On Delay Time $V_{GS} = 10 \ V, \ R_{GEN} = 6 \ \Omega$ Time $V_{GS} = 0 \ V \ to 10 \ V$ al Gate Charge $V_{GS} = 0 \ V \ to 10 \ V$ al Gate Charge $V_{GS} = 0 \ V \ to 6 \ V$ a to Source Charge $V_{GS} = 0 \ V \ to 10 \ V$ b to Drain "Miller" Charge $V_{GS} = 0 \ V, \ I_S = 7 \ A \ (Note 2)$ rese Recovery Time $I_E = 7 \ A, \ di/dt = 100 \ A/us$	Iperature CoefficientIp = 250 $\mu$ A, referenced to 25 °Cic Drain to Source On Resistance $V_{GS} = 10 V, I_D = 7 A$ $V_{GS} = 10 V, I_D = 7 A, T_J = 125 °C$ ward Transconductance $V_{DD} = 5 V, I_D = 7 A$ racteristicsit Capacitance $V_{DD} = 5 V, I_D = 7 A$ put Capacitance $V_{DS} = 50 V, V_{GS} = 0 V$ rerse Transfer Capacitance $f = 1 MHz$ e Resistance0.1aracteristics0.1aracteristics $V_{DD} = 50 V, I_D = 7 A$ n-On Delay Time $V_{CS} = 10 V, R_{GEN} = 6 \Omega$ Time $V_{GS} = 0 V to 10 V$ al Gate Charge $V_{GS} = 0 V to 10 V$ al Gate Charge $V_{GS} = 0 V to 6 V$ to Source Charge $V_{GS} = 0 V, I_S = 7 A$ e to Drain "Miller" Charge $V_{GS} = 0 V, I_S = 7 A$ Diode Characteristicsrce to Drain Diode Forward Voltage $V_{GS} = 0 V, I_S = 7 A$ $V_{FS} = 7 A, di/dt = 100 A/us$	Iperature CoefficientIp = 250 µA, referenced to 25 °C-9Ip = 250 µA, referenced to 25 °C-9VGS = 10 V, Ip = 7 A16VGS = 6 V, Ip = 5.5 A24VGS = 10 V, Ip = 7 A, TJ = 125 °C30ward TransconductanceVDD = 5 V, Ip = 7 A17racteristicstracteristicsVDS = 50 V, VGS = 0 Vf = 1 MHz6.6e ResistanceVDS = 50 V, VGS = 0 Vf = 1 MHz6.6e Resistance0.1n-On Delay TimeVDD = 50 V, Ip = 7 AColspan="2">8.4On Delay TimeVGS = 0 V to 10 VVGS = 0 V to 10 VVGS = 0 V to 10 VVGS = 0 V to 6 VVDD = 50 V11d Gate ChargeVGS = 0 V to 6 VVDD = 50 V11d Gate ChargeVGS = 0 V to 6 VVDD = 50 V11d Gate ChargeVGS = 0 V to 6 VVDD = 50 V11d Gate ChargeVGS = 0 V to 6 VVDD = 50 V11d Gate Charge2.5Diode Characteri	Inperature Coefficient         Inperature Coefficient <thinput coefficient<="" th="">         Inperature Coefficient</thinput>

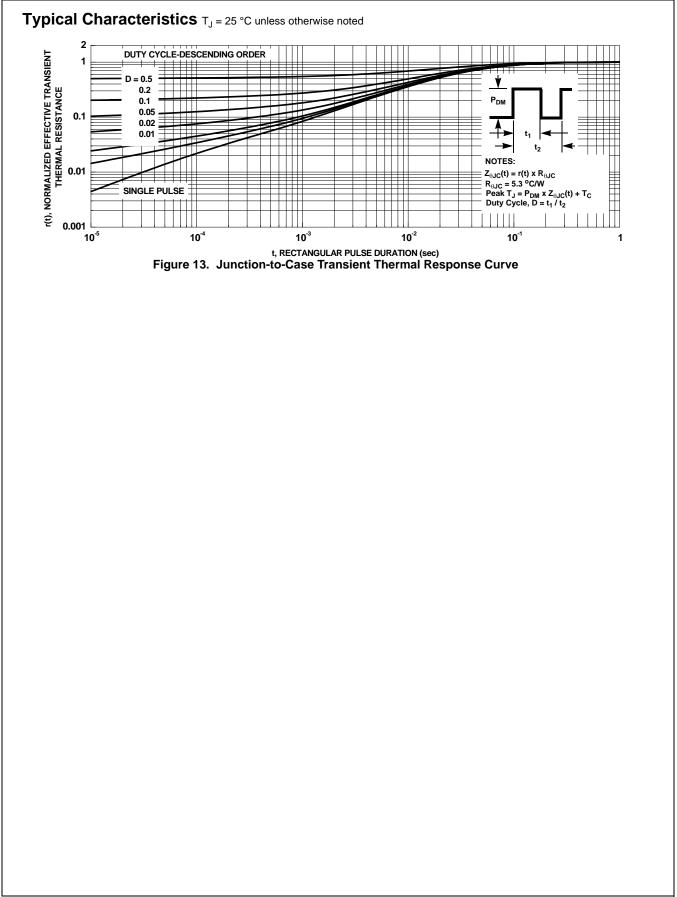


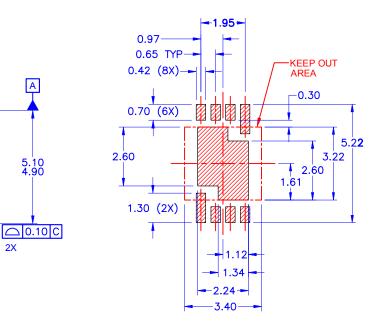
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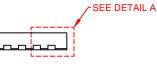


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**FRONT VIEW** 

3.40

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**TOP VIEW** 

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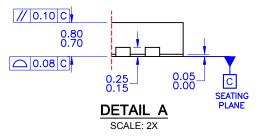
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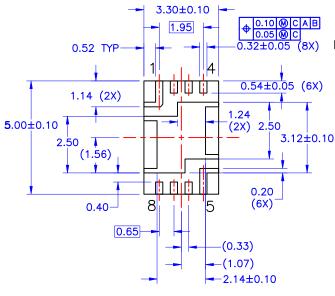
2X

0.10 C

2X

PIN#1 INDICATOR





**BOTTOM VIEW** 

NOTES: UNLESS OTHERWISE SPECIFIED

- A) DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO229 DATED 8/2012.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.
- F) DRAWING FILE NAME: MKT-PQFN08NREV1.

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